

STTH1008DTI

800 V tandem hyperfast diode

Datasheet - production data

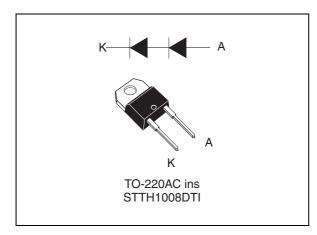


Table 1. Device summary

I _{F(AV)}	10 A
I _{FRM}	20 A
V_{RRM}	800 V
t _{rr}	40 ns
I _{RM}	8.5 A
V _F	1.7 V
Tj	150 °C

Features

- · High voltage rectifier
- Tandem diodes in series
- · Very low switching losses
- Insulated device with internal ceramic
- Equal thermal conditions for both 400 V diodes
- Static and dynamic equilibrium of internal diodes are warranted by design

Description

The STTH1008DTI is an ultrahigh performance diode composed of two 400 V dice in series.

Characteristics STTH1008DTI

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Table 2. Absolute ratings (limiting values per diode at 25 °C, unless otherwise specified)

Symbol	Parameter	Value	Unit	
V_{RRM}	Repetitive peak reverse voltage	800	V	
I _{F(RMS)}	Forward rms current		16	Α
I _{F(AV)}	Average forward current, $\delta = 0.5$	10	Α	
I _{FRM}	Repetitive peak forward current $T_c = 135$ °C, $\delta = 0.3$		20	Α
I _{FSM}	Surge non repetitive forward current	120	Α	
T _{stg}	Storage temperature range		-65 to +175	°C
T _j	Maximum junction temperature	150	°C	

Table 3. Thermal resistance

Symbol	Parameter	Value	Unit
R _{th(j-c)}	Junction to case	2.5	°C/W

Table 4. Static electrical characteristics

Symbol	Parameters	Test conditions		Min.	Тур	Max.	Unit
I _R ⁽¹⁾	Povorce leekoge gurrent	T _j = 25 °C	V -V			20	
'R`	Reverse leakage current	T _j = 150 °C	$V_R = V_{RRM}$		20	200	μΑ
	V _F ⁽²⁾ Forward voltage drop	T _c = 25 °C	I _F = 10 A		2.15	2.5	V
V (2)		T _c = 150 °C			1.7	2.05	
VF` ′		T _C = 25 °C	L = 20 A		2.45	2.85	V
		T _c = 150 °C	I _F = 20 A		2.05	2.45	

^{1.} Pulse test: $t_P = 5$ ms, $\delta < 2\%$

To evaluate the conduction losses use the following equation:

$$P = 1.65 \times I_{F(AV)} + 0.04 \times I_{F}^{2}_{(RMS)}$$

^{2.} Pulse test: t_P = 380 μ s, δ < 2%

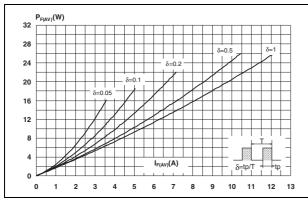
STTH1008DTI Characteristics

Table 5. Dynamic electrical characteristics

Symbol	Parameters	Test conditions		Min.	Тур	Max.	Unit
I _{RM}	Reverse recovery current	T _i = 125 °C	$T_j = 125 ^{\circ}\text{C}$ $I_F = 10 \text{A}, V_R = 400 \text{V}, \\ dI_F/dt = -200 \text{A/µs}$		8.5	11.5	А
S _{factor}	Softness factor	,	di _F /dt = -200 A/μS		0.8		
+	Reverse recovery time	$I_j = 25$ °C	$T_j = 25 ^{\circ}\text{C}$ $I_F = 1 \text{A}, \text{V}_R = 30 \text{V}, \\ dI_F/dt = -50 \text{A/}\mu\text{s}$ $I_F = 10 \text{A}, \text{V}_R = 400 \text{V}, \\ dI_F/dt = -200 \text{A/}\mu\text{s}$		40	55	20
t _{rr}	increase recovery unite	T _j = 125 °C			25 °C $I_F = 10 \text{ A}, V_R = 400 \text{ V}, \\ dI_F/dt = -200 \text{ A/µs}$		80
t _{fr}	Forward recovery time	T _j = 25 °C	-10 A V -2 V			180	ns
V _{FP}	Forward recovery voltage	T _j = 25 °C	$I_F = 10 \text{ A}, V_{FR} = 3 \text{ V},$ $dI_F/dt = 100 \text{ A/}\mu\text{s}$		4.5	7	V

Figure 1. Conduction losses versus average current

Figure 2. Forward voltage drop versus forward current (typical values)

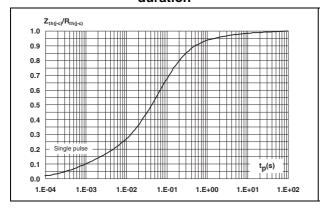


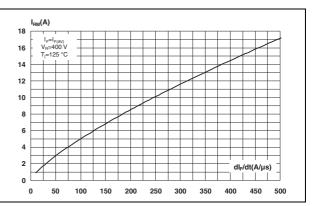
10.0 T_{=150 °C} T_{=25 °C} T_{=25 °C} V_{FM}(V)

0.1 0.0 0.5 1.0 1.5 2.0 2.5 3.0 3.5 4.0

Figure 3. Relative variation of thermal impedance junction to case versus pulse duration

Figure 4. Peak reverse recovery current versus dl_F/dt (typical values)

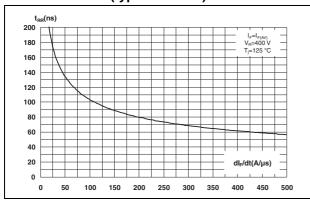




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Figure 5. Reverse recovery time versus dl_F/dt (typical values)

Figure 6. Reverse recovery charges versus dl_F/dt (typical values)



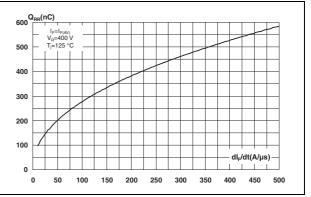
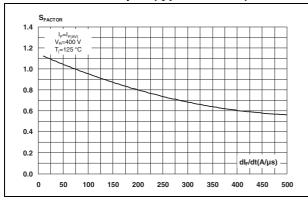
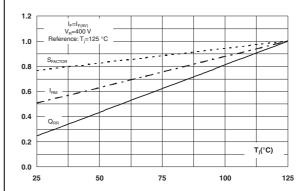


Figure 7. Reverse recovery softness factor versus dl_F/dt (typical values)

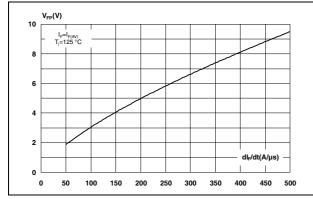
Figure 8. Relative variations of dynamic parameters versus junction temperature

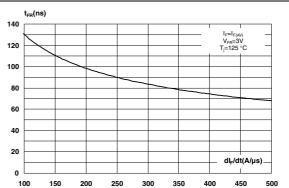




dl_F/dt (typical values)

Figure 9. Transient peak forward voltage versus Figure 10. Forward recovery time versus dl_F/dt (typical values)





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C(pF)

100

10

10

V_R(V)

1

1 10 100 1000

Figure 11. Junction capacitance versus reverse voltage applied (typical values)

Package information STTH1008DTI

2 Package information

- Epoxy meets UL94, V0
- Cooling method: by conduction (C)
- Recommended torque: 0.4 to 0.6 N·m

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Figure 12. TO-220AC ins dimension definitions

Table 6. TO-220AC ins dimension values

	Dimensions					
Ref.	. Millimeters				Inches	
	Min.	Тур.	Max.	Min.	Тур.	Max.
Α	15.20		15.90	0.598		0.625
a1		3.75			0.147	
a2	13.00		14.00	0.511		0.551
В	10.00		10.40	0.393		0.409
b1	0.61		0.88	0.024		0.034
b2	1.23		1.32	0.048		0.051
С	4.40		4.60	0.173		0.181
c1	0.49		0.70	0.019		0.027
c2	2.40		2.72	0.094		0.107
е	4.80		5.40	0.189		0.212
F	6.20		6.60	0.244		0.259
ØI	3.75		3.85	0.147		0.151
14	15.80	16.40	16.80	0.622	0.646	0.661
L	2.65		2.95	0.104		0.116
l2	1.14		1.70	0.044		0.066
М		2.60			0.102	

Ordering information STTH1008DTI

3 Ordering information

Table 7. Ordering information

Ordering code	Marking	Package	Weight	Base qty	Delivery mode
STTH1008DTI	STTH1008DTI	TO-220AC insulated	2.3 g	50	Tube

4 Revision history

Table 8. Document revision history

Date	Revision	Changes
05-Mar-2013	1	Initial release.

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